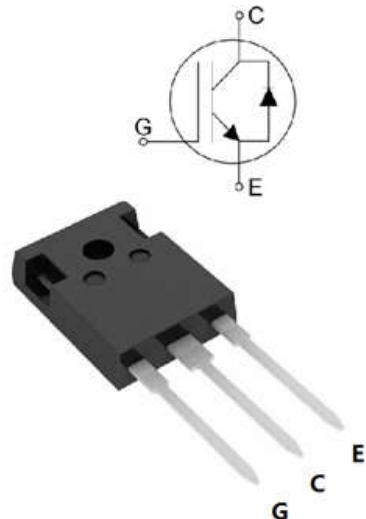


Lu-Semi 650V Trench Field Stop IGBTs offer low switching losses, high energy efficiency and high avalanche ruggedness for motion control, solar application and welding machine.

V _{CE}	650	V
I _C	50	A
V _{CE(SAT)} I _C =50A	1.8	V

FEATURES

- High breakdown voltage up to 650V for improved reliability
- Trench-Stop Technology offering :
 - High speed switching
 - High ruggedness, temperature stable
 - Short circuit withstand time – 5μs
 - Low V_{CEsat}
 - Easy parallel switching capability due to positive temperature coefficient in V_{CEsat}
- Enhanced avalanche capability



APPLICATION

- Uninterruptible Power Supplies
- Inverter
- Welding Converters
- PFC applications
- Converter with high switching frequency

Product	Package	Packaging
YGW50N65T1	TO247	Tube

Maximum Ratings ($T_j = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	650	V
DC collector current, limited by $T_{j\max}$ $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	I_C	100 50	A
Diode Forward current, limited by $T_{j\max}$ $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	I_F	100 50	A
Continuous Gate-emitter voltage	V_{GE}	± 20	V
Transient Gate-emitter voltage	V_{GE}	± 30	V
Turn off safe operating area $V_{CE} \leq 650\text{V}$, $T_j \leq 150^\circ\text{C}$, $t_p = 1\mu\text{s}$	-	150	A
Pulse collector current, $V_{GE} = 15\text{V}$, t_p limited by $T_{j\max}$	I_{CM}	150	A
Short Circuit Withstand Time, $V_{GE} = 15\text{V}$, $V_{CE} \leq 400\text{V}$	T_{sc}	5	μs
Power dissipation, $T_j = 25^\circ\text{C}$	P_{tot}	260	W
Operating junction temperature	T_j	-40...+150	$^\circ\text{C}$
Storage temperature	T_s	-55...+150	$^\circ\text{C}$
Soldering temperature, wave soldering 1.6mm (0.063in.) from case for 10s	-	260	$^\circ\text{C}$

Thermal Resistance

Parameter	Symbol	Max. Value	Unit
IGBT thermal resistance, junction - case	$R_\theta(j-c)$	0.48	K/W
Diode thermal resistance, junction - case	$R_\theta(j-c)$	0.8	K/W
Thermal resistance, junction - ambient	$R_\theta(j-a)$	40	K/W

Electrical Characteristics ($T_j = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Static						
Collector-Emitter Breakdown Voltage	BV_{CES}	$V_{\text{GE}}=0\text{V}, I_{\text{C}}=250\mu\text{A}$	650		-	V
		$V_{\text{GE}}=0\text{V}, I_{\text{C}}=1\text{mA}$	650			V
Gate Threshold Voltage	$V_{\text{GE}(\text{th})}$	$V_{\text{GE}}=V_{\text{CE}}, I_{\text{C}}=250\mu\text{A}$	4.0	5.0	6.0	V
Collector-Emitter Saturation Voltage	$V_{\text{CE}(\text{sat})}$	$V_{\text{GE}}=15\text{V}, I_{\text{C}}=50\text{A}$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	- -	1.8 2.1	2.3	V V
Zero gate voltage collector current	I_{CES}	$V_{\text{CE}} = 650\text{V}, V_{\text{GE}} = 0\text{V}$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$		0.1	40 1000	μA
Gate-emitter leakage current	I_{GES}	$V_{\text{CE}} = 0\text{V}, V_{\text{GE}} = \pm 20\text{V}$			100	nA
Transconductance	g_{fs}	$V_{\text{CE}} = 20\text{V}, I_{\text{C}} = 50\text{A}$	-	30	-	S

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Dynamic						
Input capacitance	C_{ies}	$V_{\text{CE}} = 30\text{V}, V_{\text{GE}} = 0\text{V},$ $f = 1\text{MHz}$		2800		pF
Output capacitance	C_{oes}			130		
Reverse transfer capacitance	C_{res}			75		
Gate charge	Q_{G}	$V_{\text{CC}} = 520\text{V}, I_{\text{C}} = 50\text{A},$ $V_{\text{GE}} = 15\text{V}$	-	180	-	nC
Short circuit collector current	$I_{\text{C}(\text{SC})}$	$V_{\text{GE}}=15\text{V}, t_{\text{sc}} \leq 5\text{us}$ $V_{\text{CC}}=400\text{V},$ $T_{j, \text{start}}=25^\circ\text{C}$	-	310	-	A

Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Dynamic T_j=25°C						
Turn-on Delay Time	t _{d(on)}	V _{CC} = 400V, I _C = 50.0A, V _{GE} = 0.0/15.0V, R _g =12Ω	-	40	-	ns
Rise Time	t _r		-	22	-	ns
Turn-off Delay Time	t _{d(off)}		-	180	-	ns
Fall Time	t _f		-	88	-	ns
Turn-on Energy	E _{on}		-	1.9	-	mJ
Turn-off Energy	E _{off}		-	1.1	-	mJ
Dynamic T_j=150°C						
Turn-on Delay Time	t _{d(on)}	V _{CC} = 400V, I _C = 50.0A, V _{GE} = 0.0/15.0V, R _g =12Ω	-	40	-	ns
Rise Time	t _r		-	25	-	ns
Turn-off Delay Time	t _{d(off)}		-	195	-	ns
Fall Time	t _f		-	100	-	ns
Turn-on Energy	E _{on}		-	2.2	-	mJ
Turn-off Energy	E _{off}		-	1.25	-	mJ

Electrical Characteristics of the DIODE (T_j= 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Dynamic						
Diode Forward Voltage	V _{FM}	I _F = 50A	-	1.9	-	V
Reverse Recovery Time	T _{rr}	I _F = 50A, V _R = 400V, di/dt= 100A/μs,	-	20	-	ns
Reverse Recovery Current	I _{rr}		-	10	-	A
Reverse Recovery Charge	Q _{rr}		-	100	-	nC

Fig. 1 FBSOA characteristics

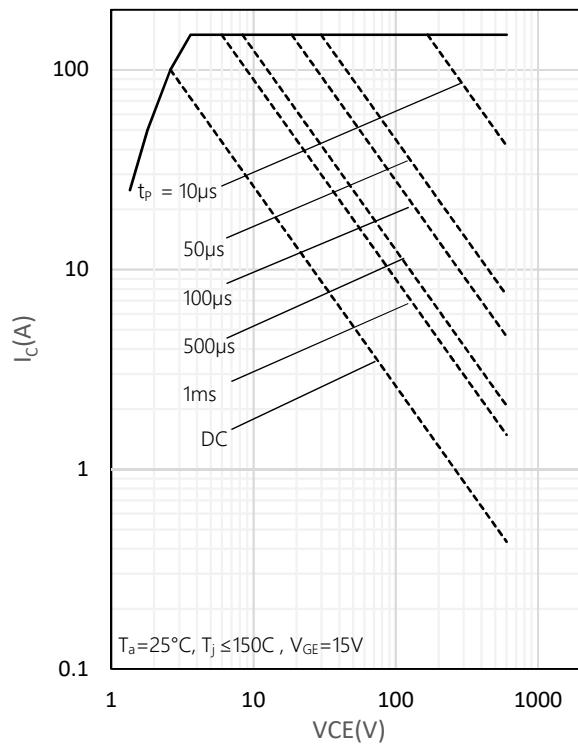


Fig. 2 Load Current vs. Frequency

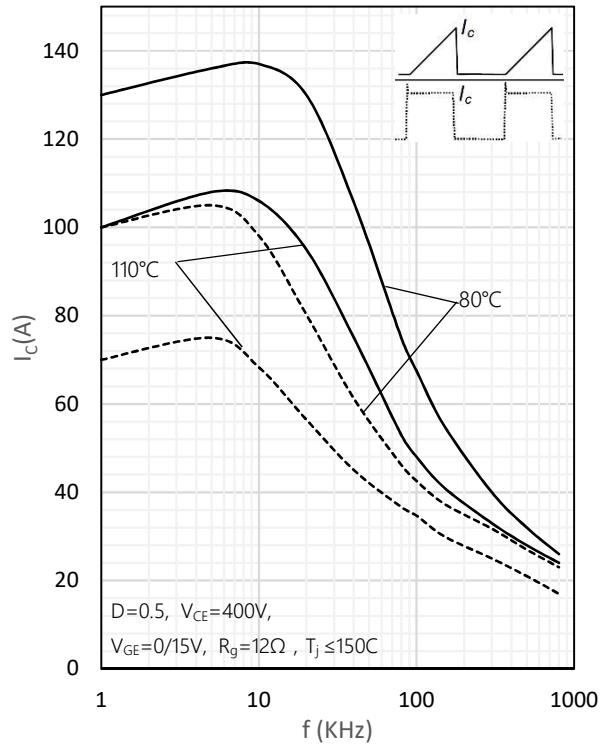
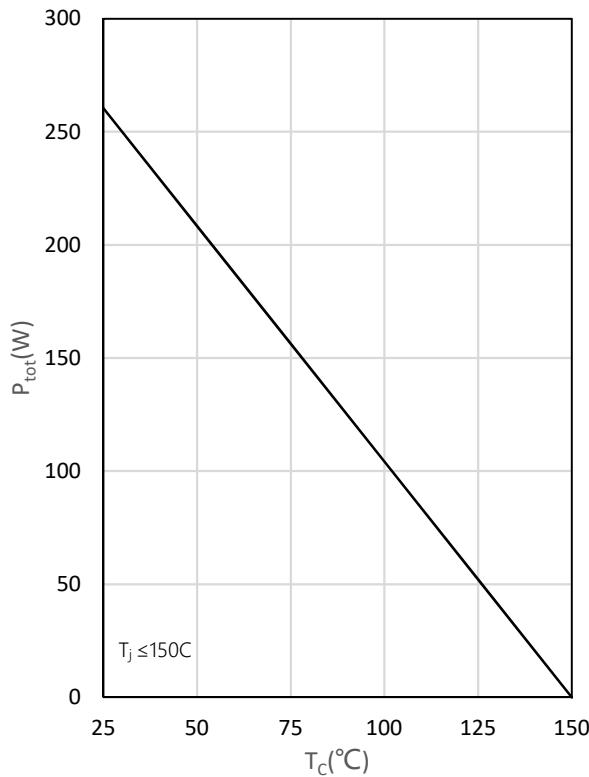
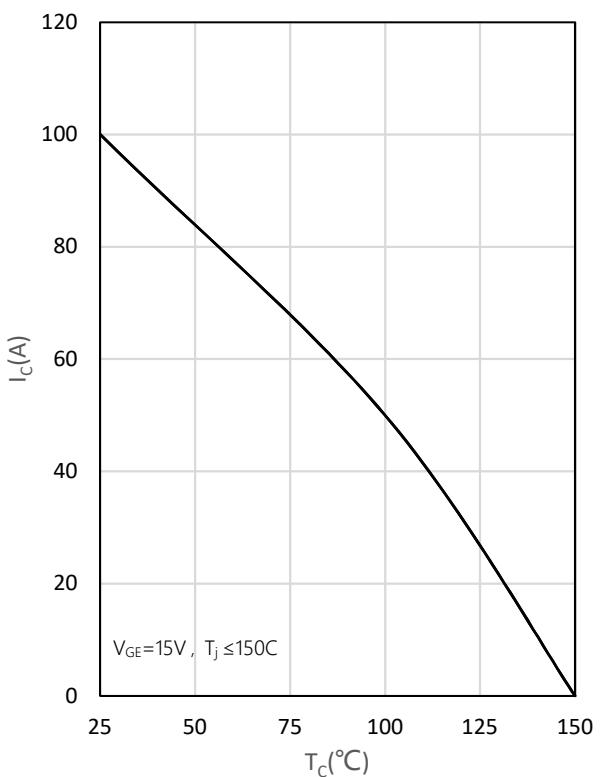

 Fig. 3 Power dissipation as a function of T_C

 Fig. 4 collector current as a function of T_C


Fig. 5 Output characteristics

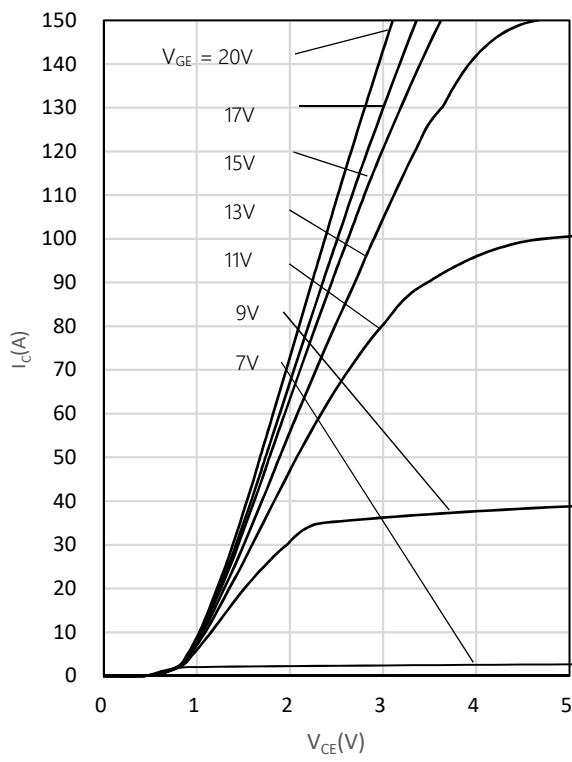


Fig. 6 Saturation voltage characteristics

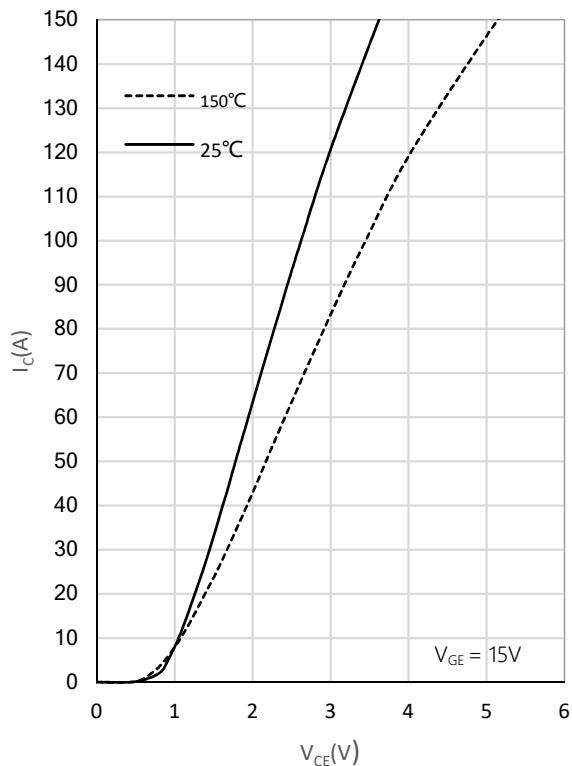


Fig. 7 Switching times vs. gate resistor

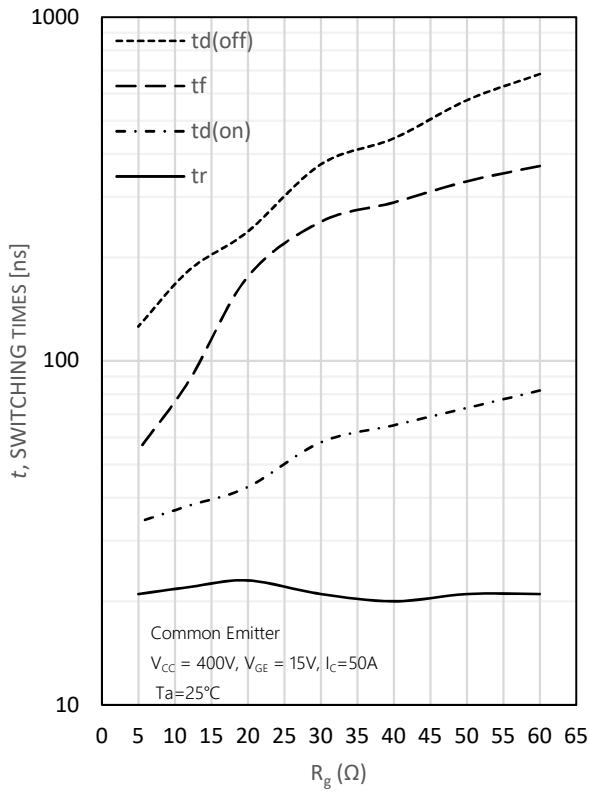


Fig. 8 Switching times vs. collector current

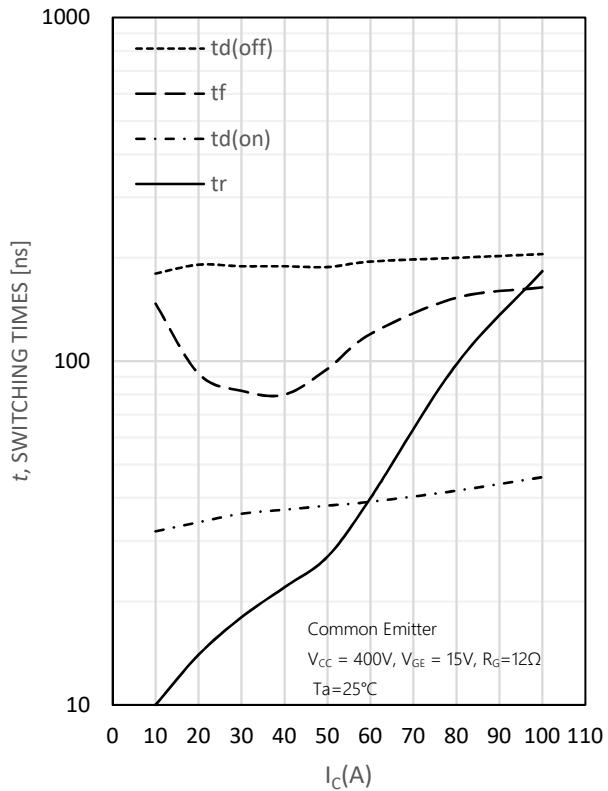


Fig. 9 Switching loss vs. gate resistor

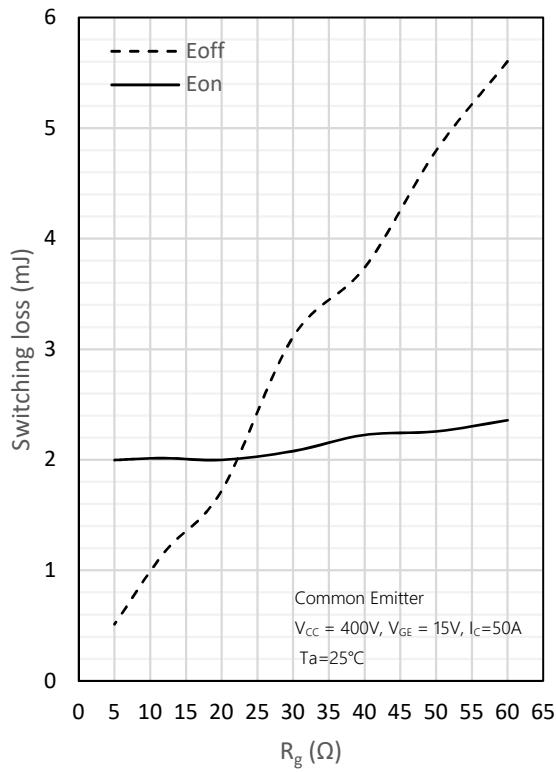


Fig. 10 Switching loss vs. collector current

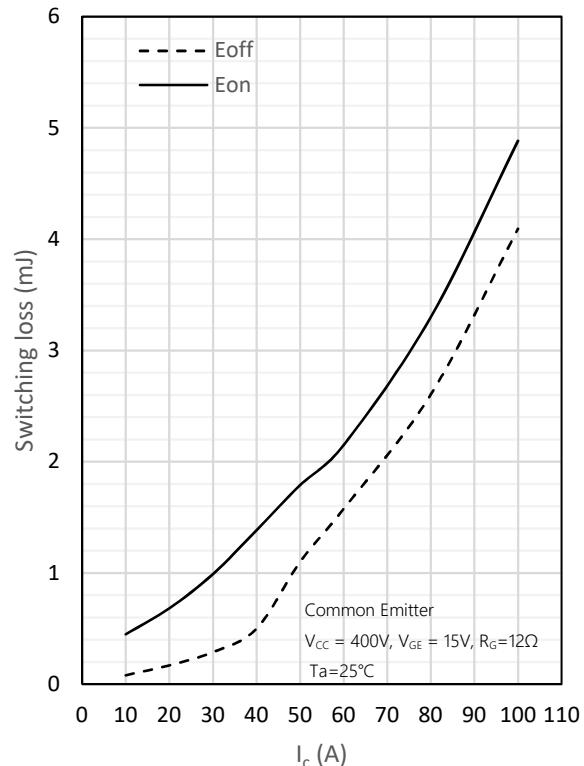


Fig. 11 Gate charge characteristics

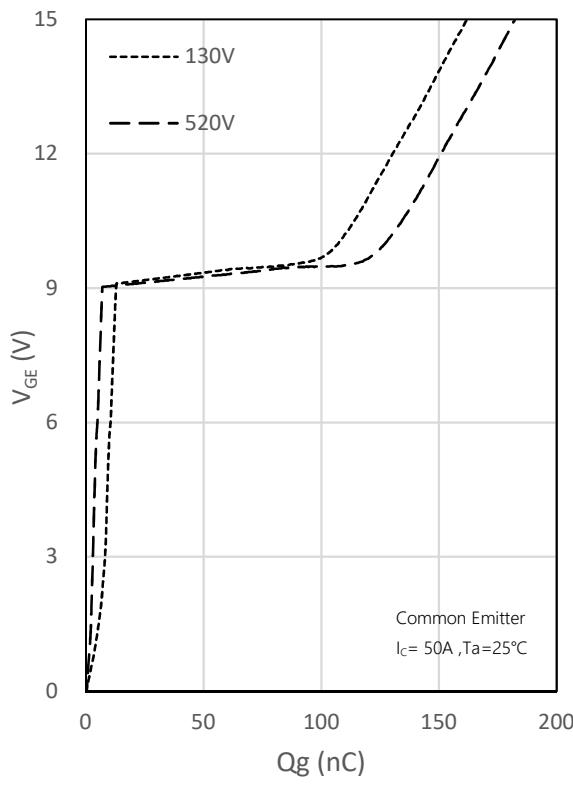
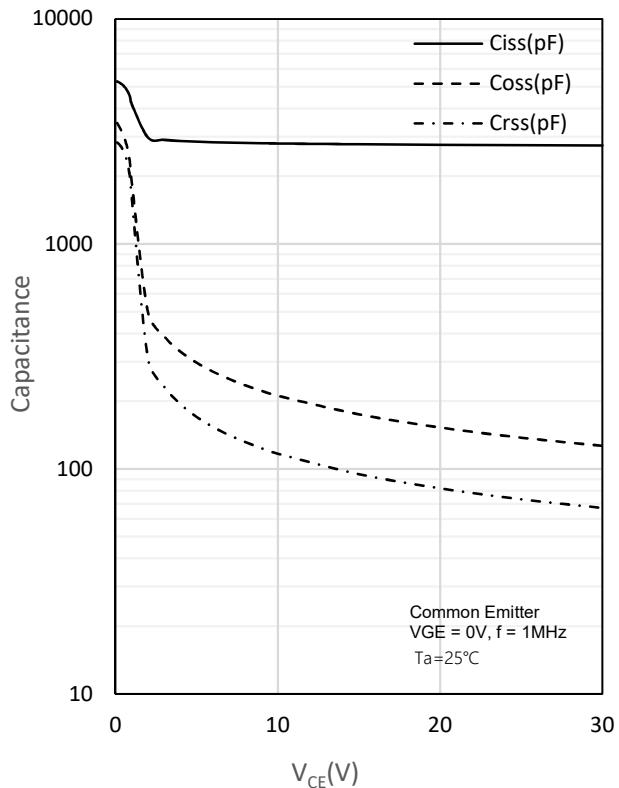
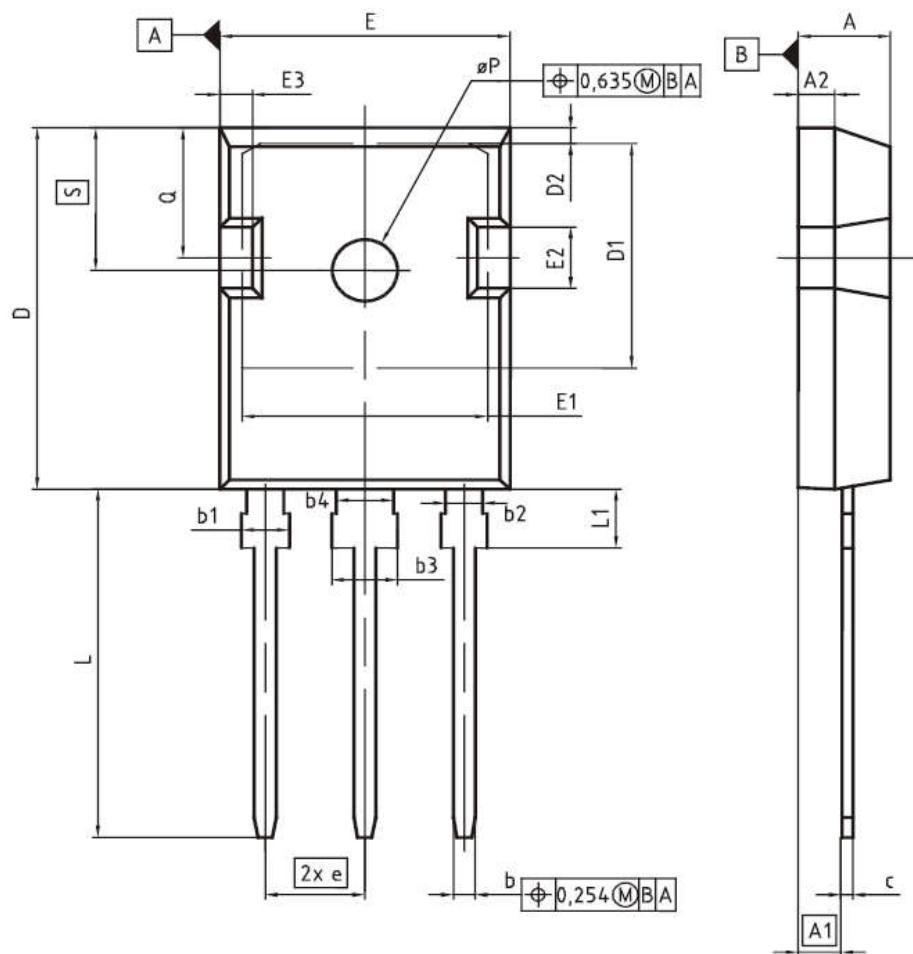


Fig. 12 Capacitance characteristics



PG-T0247-3


DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.27	2.54	0.089	0.100
A2	1.85	2.16	0.073	0.085
b	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
c	0.55	0.68	0.022	0.027
D	20.80	21.10	0.819	0.831
D1	16.25	17.65	0.640	0.695
D2	0.95	1.35	0.037	0.053
E	15.70	16.13	0.618	0.635
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.00	2.60	0.039	0.102
e	5.44 (BSC)		0.214 (BSC)	
N	3		3	
L	19.80	20.32	0.780	0.800
L1	4.10	4.47	0.161	0.176
ØP	3.50	3.70	0.138	0.146
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248